



Click [here](#) for the 3D model.

### Dimensions

Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.85mm +/-0.07mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

### Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

### General Information

Series	SMD Auto COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Automotive Grade
Features	Ultra-Stable, Low Loss, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	2200 pF
Measurement Condition	1kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms